MICROCHIP

MTD6505

Sinusoidal Sensorless 3-Phase Brushless DC Fan Motor Driver

Features

- 180° Sinusoidal Drive, for high efficiency and low acoustic noise
- Position Sensorless BLDC Drivers (No Hall-effect sensor required)
- Integrated Power Transistors
- Supports 2V to 5.5V Power Supplies
- Programming Resistor (R_{PROG}) setting to fit motor constant (Km) range from 3.25 mV/Hz to 52 mV/Hz
- Direction Control:
  - Forward direction: connect DIR pin to GND or leave floating
  - Reverse direction: connect DIR pin to V_{BIAS} or 3V
- Speed Control through Power Supply Modulation (PSM) and/or Pulse-Width Modulation (PWM)
- Built-in Frequency Generator (FG Output Signal)
- Built-in Lockup Protection and Automatic Recovery Circuit
- Built-in Overcurrent Limitation
- Built-in Thermal Shutdown Protection
- Built-in Over Voltage Protection
- No External Tuning Required
- Available Package
  10-Lead 3mm x 3mm UDFN

Applications

- Notebook CPU Cooling Fans
- 5V 3-Phase BLDC Motors

Description

The MTD6505 device is a 3-phase full-wave sensorless driver for brushless DC (BLDC) motors. It features 180° sinusoidal drive, high torque output and silent drive. With the adaptive features, parameters and wide range of power supplies (2V to 5.5V), the MTD6505 is intended to cover a broad range of motor characteristics, while requiring minimum external components. Speed control can be achieved through either power supply modulation (PSM) or pulse-width modulation (PWM).

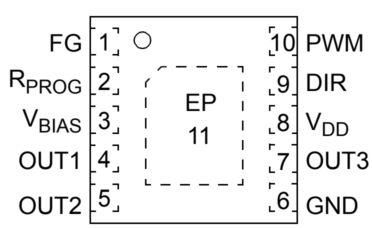
The compact packaging and the minimal bill-of-material make the MTD6505 device extremely cost efficient in fan applications. For example, the CPU cooling fans in notebook computers require designs that provide low acoustic noise, low mechanical vibration, and are highly efficient. The frequency generator (FG) output enables precision speed control in closed-loop applications.

The MTD6505 device includes Lockup Protection mode to turn off the output current when the motor is in a lock condition, with an automatic recovery feature to restart the fan when the lock condition is removed. Motor overcurrent limitation and thermal shutdown protection are included for safety enhanced operations.

The MTD6505 is available in a compact, thermally enhanced, 3mm x 3mm 10-lead UDFN package.

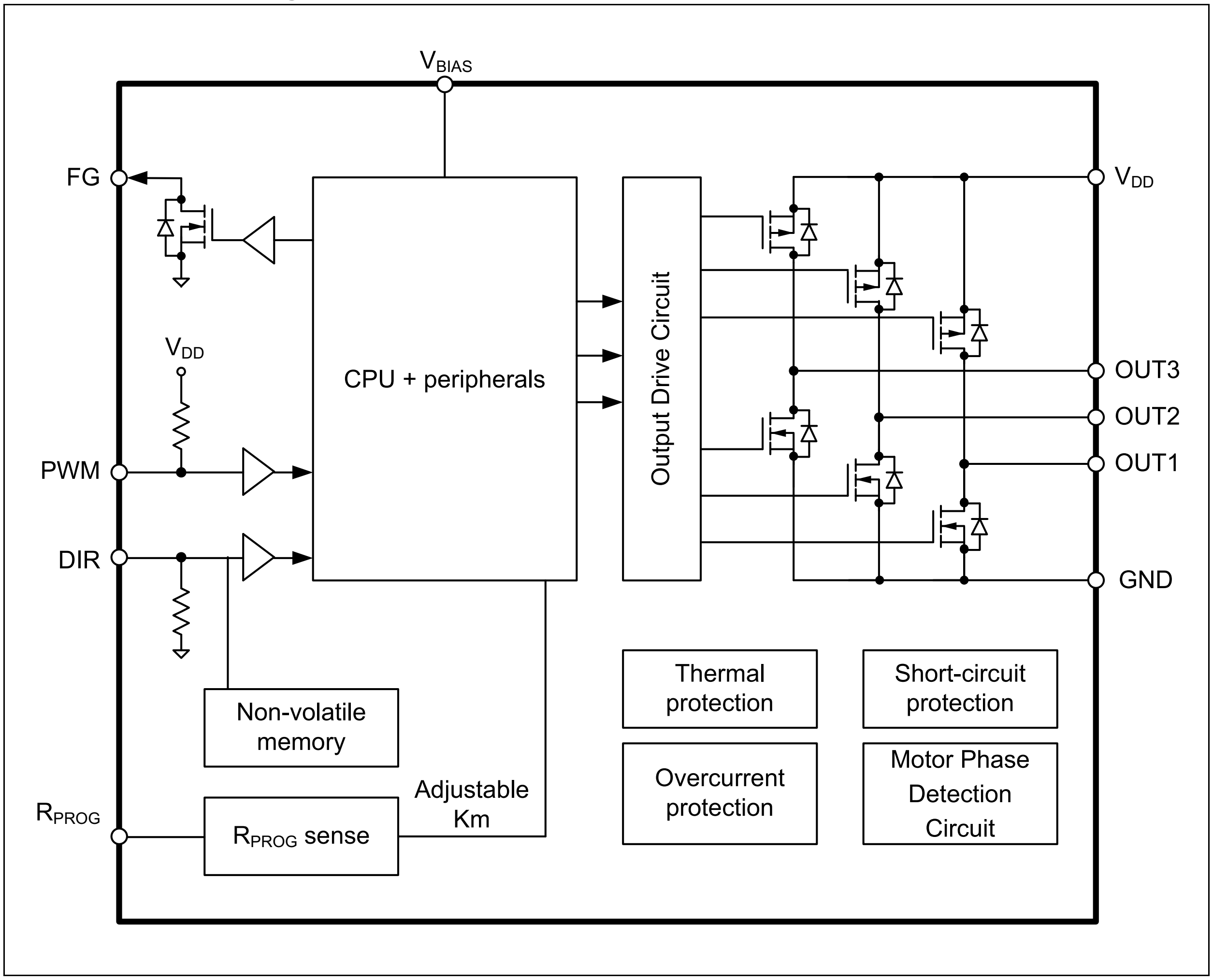
Package Types

MTD6505
3x3 UDFN*

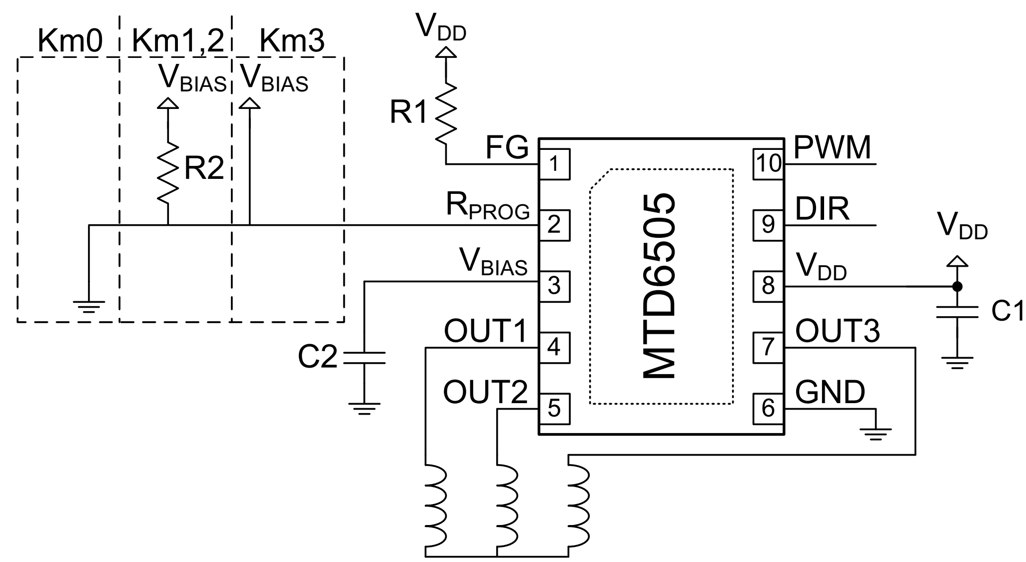


*Includes Exposed Thermal Pad (EP); see Table 3-1.

Functional Block Diagram



Typical Application



Recommended External Components for Typical Application

Element	Type/Value	Comment
C1	≥1 µF	Connect as close as possible to IC input pins.
C2	≥1 µF	Connect as close as possible to IC input pins.
R1	≥10 kΩ	Connect to Vlogic on microcontroller side (FG Pull-Up).
R2	3.9 kΩ or 24 kΩ	Select appropriate programming resistor value, see Table 4-2: Km Settings.

NOTES:

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Power Supply Voltage (V_{DD_MAX}) .... -0.7 to +7.0V
Maximum Output Voltage (V_{OUT_MAX}) .... -0.7 to +7.0V
Maximum Output Current[(2)] (I_{OUT_MAX}) ....1000 mA
FG Maximum Output Voltage (V_{FG_MAX}) .... -0.7 to +7.0V
FG Maximum Output Current (I_{FG_MAX}) ....5.0 mA
V_{DD} Maximum Voltage (V_{DD_MAX}) .... -0.7 to +4.0V
PWM Maximum Voltage (V_{PWM_MAX}) .... -0.7 to +7.0V
Allowable Power Dissipation[(1)](P_{D_MAX})........................1.5W
Max Junction Temperature (T_J).................................. +150°C
ESD protection on all pins ....≥2 kV

† Notice: Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: Reference PCB, according to JEDEC standard EIA/JESD 51-9.

2: I_{OUT} is also internally limited, according to the limits defined in the Electrical Characteristics table.

ELECTRICAL CHARACTERISTICS

Electrical Specifications: Unless otherwise specified, all limits are established for V_{DD} = 5.5V to 2.0V, T_A = +25°C

Parameters	Sym	Min	Typ	Max	Units	Conditions
Power Supply Voltage	V_{DD}	2	—	5.5	V	
Power Supply Current	I_{VDD}	—	5	10	mA	V_{DD} = 5V
Standby Current	I_{VDD_STB}	—	30	40	µA	PWM = 0V, V_{DD} = 5V (Standby mode)
OUT1 High Resistance	$R_{ON(H)}$	—	0.75	—	Ω	I_{OUT} = 0.5A, V_{DD} = 5V
OUT2 Low Resistance	$R_{ON(L)}$	—	0.75	—	Ω	I_{OUT} = 0.5A, V_{DD} = 5V
OUT3 Total Resistance	$R_{ON(H+L)}$	—	1.5	—	Ω	I_{OUT} = 0.5A, V_{DD} = 5V
V_{BIAS} Internal Supply Voltage	V_{BIAS}	—	3	—	V	V_{DD} = 3.2V to 5.5V
		—	V_{DD} – 0.2	—	V	V_{DD} < 3.2V
PWM Input Frequency	f_{PWM}	1	—	100	kHz	
PWM Input H Level	V_{PWM_H}	0.55*V_{DD}	—	V_{DD}	V	V_{DD} ≥ 4.5V
PWM Input L Level	V_{PWM_L}	0	—	0.2*V_{DD}	V	V_{DD} ≥ 4.5V
PWM Internal Pull-Up Resistor	R_{PWM_0}	—	266	—	kΩ	PWM = 0V
PWM Internal Pull-Up Resistor	R_{PWM}	—	133	—	kΩ	PWM duty-cycle > 0%
DIR Input H Level	V_{DIR_H}	0.55*V_{DD}	—	V_{DD}	V	V_{DD} ≥ 4.5V
DIR Input L Level	V_{DIR_L}	0	—	0.2*V_{DD}	V	V_{DD} ≥ 4.5V
DIR Internal Pull-Down Resistor	R_{DIR}	100	—	200	kΩ	
FG Output Pin Low Level Voltage	V_{OL_FG}	—	—	0.25	V	I_{FG} = -1 mA
FG Output Pin Leakage Current	I_{LH_FG}	-10	—	10	µA	V_{FG} = 5.5V

Note 1: 750 mA is the standard option for MTD6505. Additional overcurrent protection levels are available upon request. Please contact factory for different overcurrent protection values.

2: Related to the internal oscillator frequency (see Figure 2-1)

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Specifications: Unless otherwise specified, all limits are established for V_{DD} = 5.5V to 2.0V, T_A = +25°C

Parameters	Sym	Min	Typ	Max	Units	Conditions
Lock Protection Operating Time	T_{RUN}	—	0.5	—	s	
Lock Protection Waiting Time	T_{WAIT}	4.5	5	5.5	s	Note 2
Overcurrent Protection	I_{OC_MOT}	—	750	—	mA	
Overvoltage Protection	V_{OV}	—	7.2	—	V	
Short Protection on High Side	$I_{OC\_SW\_H}$	—	2.57	—	A	
Short Protection on Low Side	$I_{OC\_SW\_L}$	—	-2.83	—	A	
Thermal Shutdown	T_{SD}	—	170	—	°C	
Thermal Shutdown Hysteresis	T_{SD_HYS}	—	25	—	°C	

Note 1: 750 mA is the standard option for MTD6505. Additional overcurrent protection levels are available upon request. Please contact factory for different overcurrent protection values.

2: Related to the internal oscillator frequency (see Figure 2-1)

TEMPERATURE SPECIFICATIONS

Electrical Specifications: Unless otherwise specified, all limits are established for V_{DD} = 5.5V to 2.0V, T_A = +25°C.

Parameters	Sym	Min	Typ	Max	Units	Conditions
Temperature Ranges						
Operating Temperature	T_{OPR}	-40	—	+125	°C	
Storage Temperature Range	T_{STG}	-55	—	+150	°C	
Thermal Package Resistances						
Thermal Resistance, 10L-UDFN	θ_{JA}	—	96.6	—	°C/W	

2.0 TYPICAL PERFORMANCE CURVES

Note:	The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

Note: Unless indicated, T_A = +25°C, V_{DD} = 5.5V to 2.0V, OUT1, 2, 3 and PWM open.

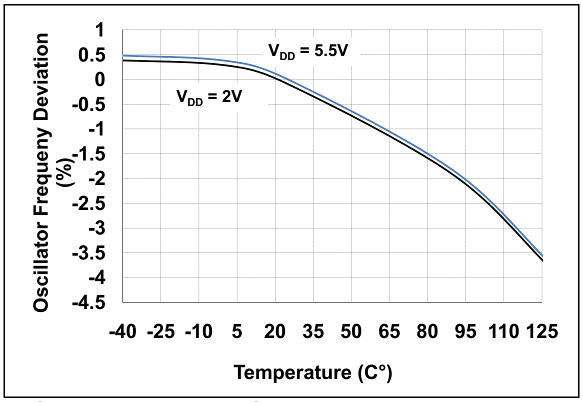


FIGURE 2-1: Oscillator Frequency Deviation vs. Temperature.

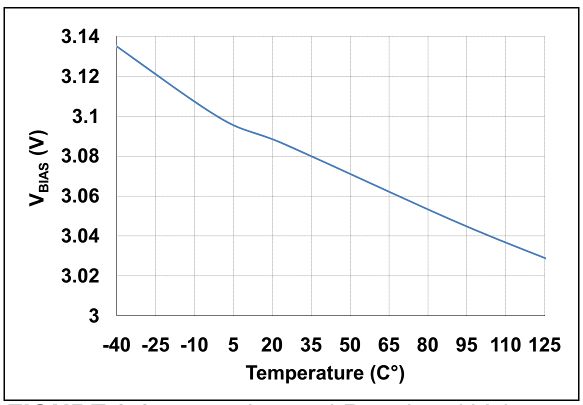


FIGURE 2-2: Internal Regulated Voltage (V_{BIAS}) vs Temperature.

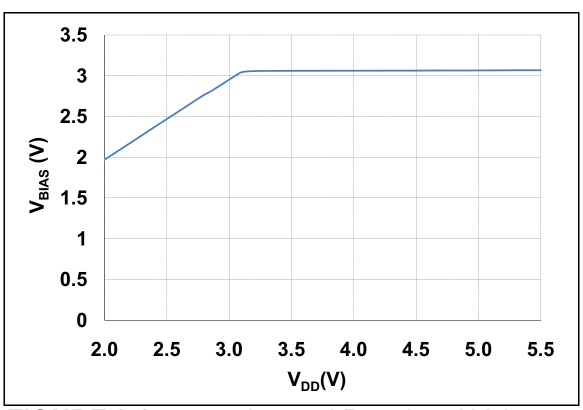


FIGURE 2-3: Internal Regulated Voltage (V_{BIAS}) vs Supply Voltage (V_{DD}).

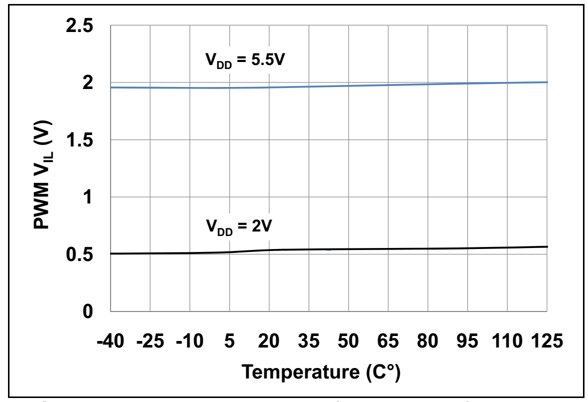


FIGURE 2-4: Inputs (PWM, DIR) V_{IL} vs. Temperature.

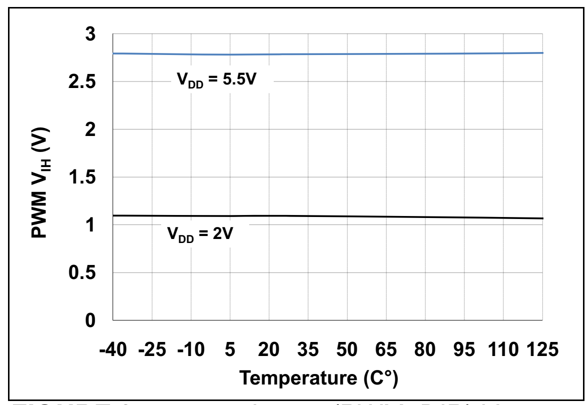


FIGURE 2-5: Inputs (PWM, DIR) V_{IH} vs. Temperature.

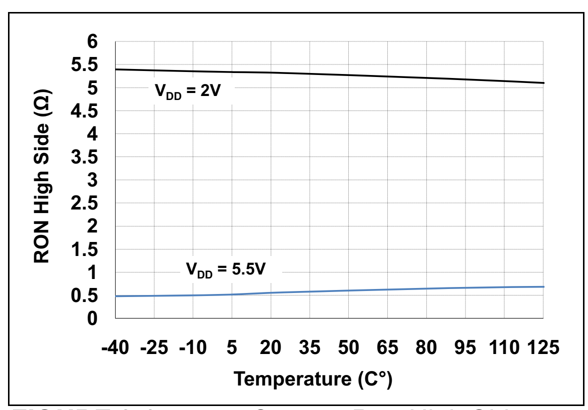


FIGURE 2-6: Outputs R_{ON} High Side Resistance vs. Temperature.

Note: Unless indicated, T_A = +25°C, V_{DD} = 5.5V to 2.0V, OUT1, 2, 3 and PWM open.

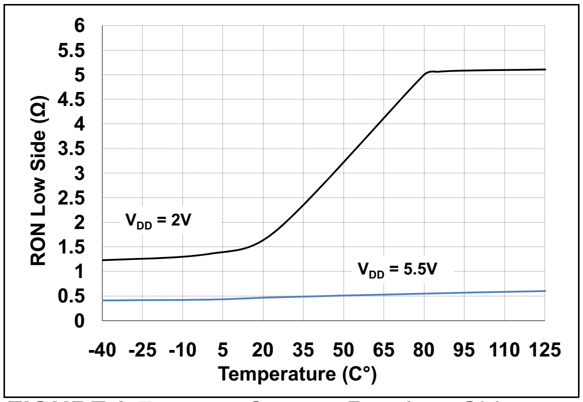


FIGURE 2-7: *Outputs R_{ON} Low Side Resistance vs. Temperature.*

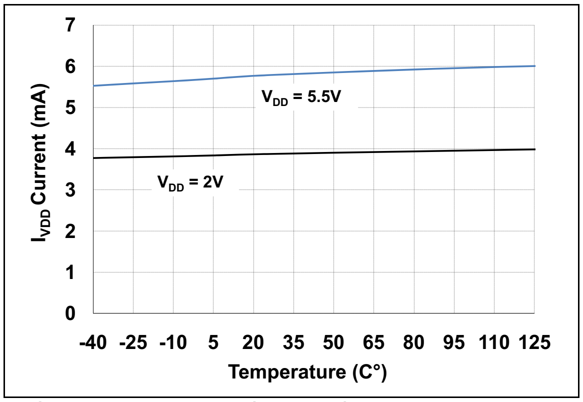


FIGURE 2-8: *Supply Current vs. Temperature.*

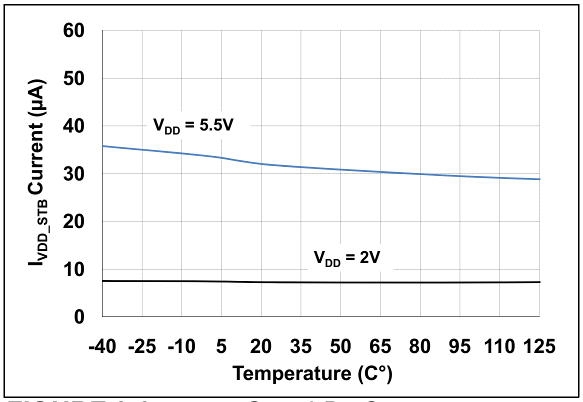


FIGURE 2-9: *Stand-By Current vs. Temperature.*

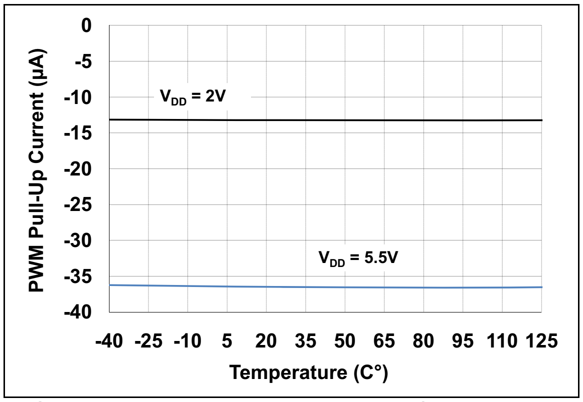


FIGURE 2-10: *PWM Pull-Up Current vs. Temperature.*

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: MTD6505 PIN FUNCTION TABLE

Pin Number	Type	Name	Function
1	O	FG	Motor speed indication output
2	I	R_{PROG}	Km parameter setting with external resistors, see Table 4-2 for values
3	—	V_{BIAS}	Internal regulator output (for decoupling only)
4	O	OUT1	Single phase coil output pin
5	O	OUT2	Single phase coil output pin
6	—	GND	Negative voltage supply (ground)
7	O	OUT3	Single phase coil output pin
8	—	V_{DD}	Positive voltage supply for motor driver
9	I	DIR	Motor Rotation Direction - Forward direction: connect pin to GND or leave floating - Reverse direction: connect pin to V_{BIAS}
10	I	PWM	PWM input signal for speed control
11	—	EP	Exposed pad (can be connected to the ground plan for better thermal dissipation)

Legend: I = Input; O = Output

4.0 FUNCTIONAL DESCRIPTION

The MTD6505 generates a full-wave signal to drive a 3-phase BLDC motor. High efficiency and low-power consumption are achieved due to CMOS transistors and synchronous rectification drive type.

4.1 Speed Control

The rotational speed of the motor can be controlled either through the PWM digital input signal or by acting directly on the power supply (V_{DD}). When the PWM signal is High (or left open), the motor rotates at full speed. When the PWM signal is low, the IC outputs are set to high-impedance and the motor is stopped.

By changing the PWM duty cycle, the speed can be adjusted. Thus, the user has maximum freedom to choose the PWM system frequency within a wide range (from 1 kHz to 100 kHz).

Since the PWM pin has an internal pull-up resistor connected to V_{DD}, it is recommended to drive it between 0V and High-Z. The PWM driver must be able to support the pull-up resistor current, in order to drive the pin. See “PWM Internal Pull-Up Resistor” in Section 1.0, Electrical Characteristics.

The output transistor activation always occurs at a fixed rate of 30 kHz, which is outside of the range of audible frequencies.

Note 1: The PWM frequency has no direct affect on the motor speed and is asynchronous with the activation of the output transistors.

Note 2: The standard output frequency is 30 kHz. A 20 kHz output frequency option is available upon request.

4.2 Motor Rotation Direction

The current-carrying order of the outputs depends on the DIR pin state (“Rotation Direction”) and is described in Table 4-1. The DIR pin is not designed for dynamic direction change during operation.

TABLE 4-1: MOTOR ROTATION DIRECTION OPTIONS (DIR PIN)

DIR Pin State	Rotation Direction	Outputs Activation Sequence
Connected to GND or Floating	Forward	OUT1 → OUT2 → OUT3
Connected to V_{BIAS}	Reverse	OUT3 → OUT2 → OUT1

4.3 Frequency Generator Function

The Frequency Generator output (FG) is a “Hall-effect sensor equivalent” digital output, giving information to an external controller about the speed and phase of the motor. The FG pin is an open drain output, connecting to a logical voltage level through an external pull-up resistor. When a lock, or an out-of-sync situation is detected by the driver, this output is set to high-impedance until the motor is restarted. Leave the pin open when it is not used.

4.4 Lockup Protection and Automatic Restart

If the motor is blocked and cannot rotate freely, a lock-up protection circuit detects it and disables the driver by setting its outputs to high-impedance to prevent the motor coil from burnout. After a “waiting time” (T_{WAIT}), the lock-up protection is released and normal operation resumes for a given time (T_{RUN}). If the motor is still blocked, a new period of waiting time is started. T_{WAIT} and T_{RUN} timings are fixed internally, so that no external capacitor is required.

4.5 Overcurrent Protection

The motor peak current is limited by the driver to 750 mA (standard value), thus limiting the maximum power dissipation in the coils.

4.6 Thermal Shutdown

The MTD6505 device has a thermal protection function which detects when the die temperature exceeds T_J = +170°C. When this temperature is reached, the circuit enters the Thermal Shutdown mode, and the outputs OUT1, OUT2 and OUT3 are disabled (high-impedance), avoiding the IC destruction and allowing the circuit to cool down. When the junction temperature (T_J) drops below +145°C, normal operation resumes.

The thermal detection circuit has +25°C hysteresis.

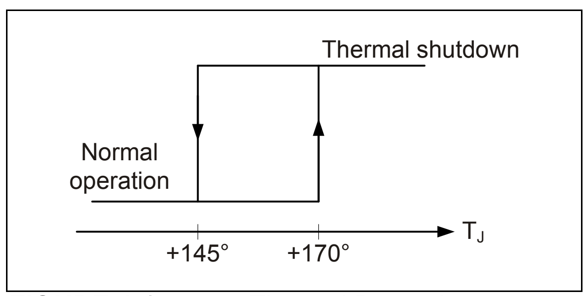


FIGURE 4-1: Thermal Protection Hysteresis.

4.7 Internal Voltage Regulator

V_{BIAS} voltage is generated internally and is used to supply internal logical blocks. The V_{BIAS} pin is used to connect an external decoupling capacitor (1 µF or higher). Notice that this pin is for IC internal use, and is not designed to supply DC current to external blocks.

4.8 BEMF Coefficient Setting

Km is the electro-mechanical coupling coefficient of the motor (also referred to as “motor constant” or “BEMF constant”). Depending on the conventions in use, the exact definition of Km and its measurement criteria can vary among motor manufacturers. To accommodate various motor applications, the MTD6505 provides options to facilitate diverse BEMF coefficients.

The MTD6505 defines BEMF coefficient (Km) as the peak value of the phase-to-phase BEMF voltage, normalized to the electrical speed of the motor. The following table offers methods to set the Km value for the MTD6505 device.

TABLE 4-2: Km SETTINGS

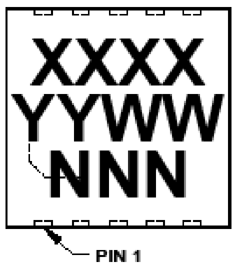
Km Option	Km (mV/Hz) Range Phase-to-Phase		R_{PROG}
	Min	Max	
Km0	3.25	6.5	GND
Km1	6.5	13	24 kΩ
Km2	13	26	3.9 kΩ
Km3	26	52	V_{BIAS}

The R_{PROG} sensing is actually a sequence that is controlled by the firmware. For any given R_{PROG}, the internal control block will output the corresponding Km range.

5.0 PACKAGING INFORMATION

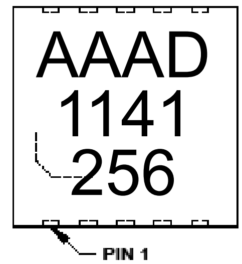
5.1 Package Marking Information

10-Lead UDFN (3x3x0.5 mm)



Device	Code
MTD6505T-E/NA	AAAD

Example

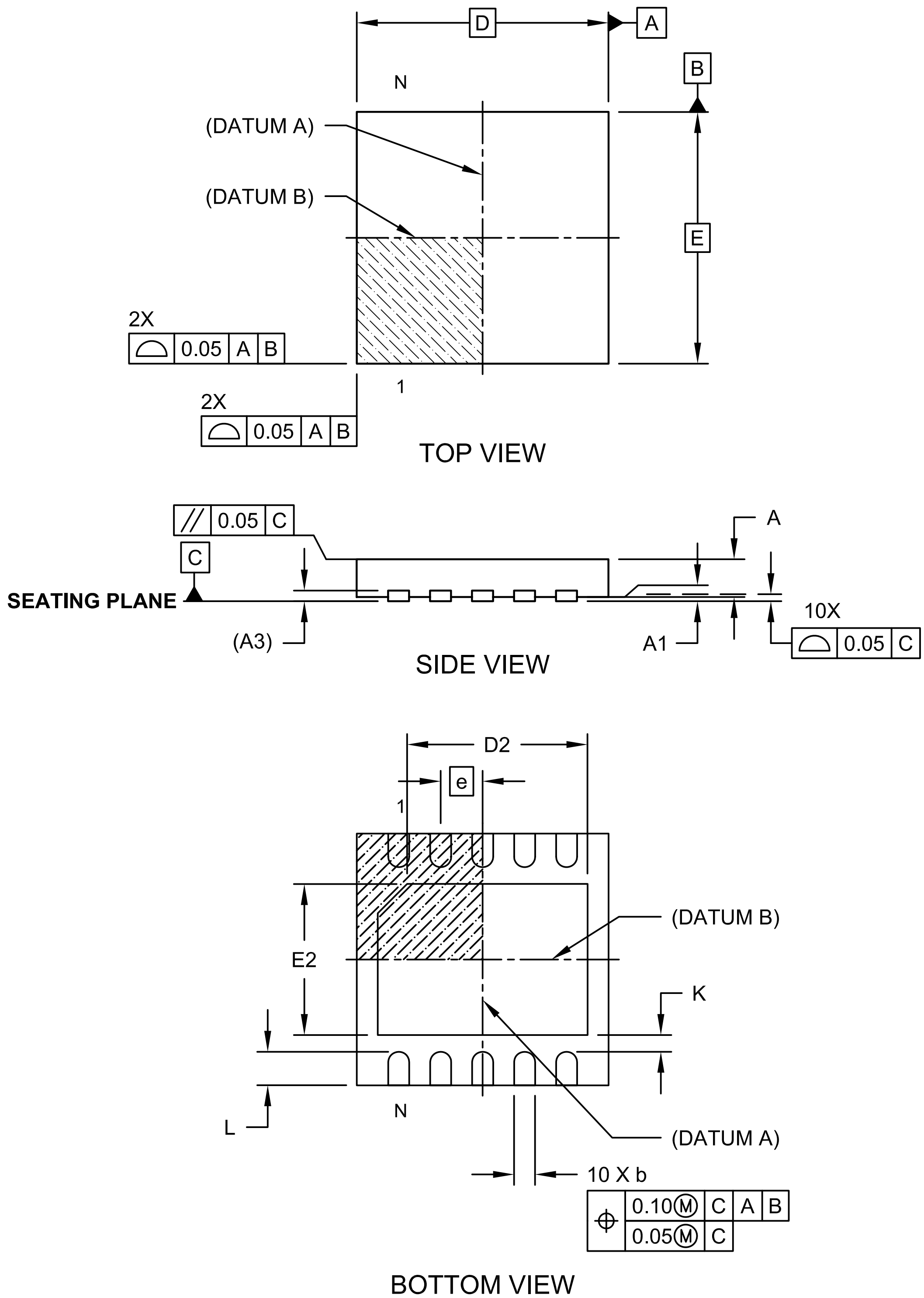


Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

10-Lead Ultra-thin Dual Flatpack No-Lead (NA[Y]) – 3x3x0.5 mm Body [UDFN]

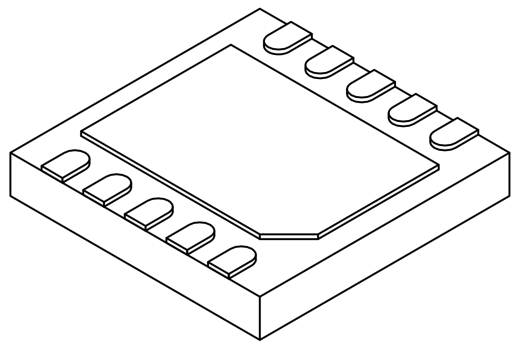
Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-194A Sheet 1 of 2

10-Lead Ultra-thin Dual Flatpack No-Lead (NA[Y]) – 3x3x0.5 mm Body [UDFN]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Pins	N		10	
Pitch	e		0.50 BSC	
Overall Height	A	0.45	0.50	0.55
Standoff	A1	0.00	-	0.05
Overall Length	D		3.00 BSC	
Overall Width	E		3.00 BSC	
Exposed Pad Length	D2	2.40	2.50	2.60
Exposed Pad Width	E2	1.70	1.80	1.90
Terminal Thickness	(A3)		0.127 REF	
Terminal Width	b	0.20	0.25	0.30
Terminal Length	L	0.30	0.40	0.50
Terminal-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package may have one or more exposed tie bars at ends.
2. Package is saw singulated
4. Dimensioning and tolerancing per ASME Y14.5M.
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-194A Sheet 2 of 2

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (November 2011)

This is the original release of this document.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	T	-X	/XX
Device	Tape & Reel	Temperature	Package

Device:	MTD6505T:		3-Phase Brushless DC, Sinusoidal Sensorless Fan Motor Driver (Tape and Reel)
Temperature Range:	E	=	Extended -40°C to +125°C
Package:	NA	=	Plastic Dual Flat, thermally-enhanced, 3x3x0.5 mm Body (UDFN)

Examples:

a) MTD6505T-E/NA Tape and Reel, Extended Temperature 10LD UDFN Package

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

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